

BSS138

Power MOSFET

N-CHANNEL LOGIC LEVEL ENHANCEMENT MODE

DESCRIPTION

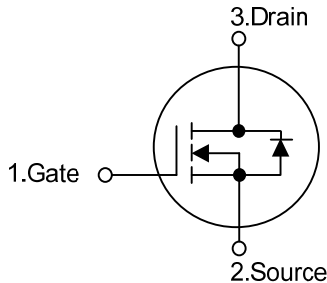
This device employs advanced MOSFET technology and features low gate charge while maintaining low on-resistance.

Optimized for switching applications, this device improves the overall efficiency of DC/DC converters and allows operation to higher switching frequencies.

FEATURES

- * $R_{DS(ON)} \leq 3.5 \Omega @ V_{GS}=10V, I_D=0.22A$
- $R_{DS(ON)} \leq 6.0 \Omega @ V_{GS}=4.5V, I_D=0.22A$
- $R_{DS(ON)} \leq 8.0 \Omega @ V_{GS}=2.5V, I_D=0.20A$
- * Low Capacitance
- * Low Gate Charge
- * Fast Switching Capability
- * Avalanche Energy Specified

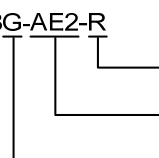
SYMBOL

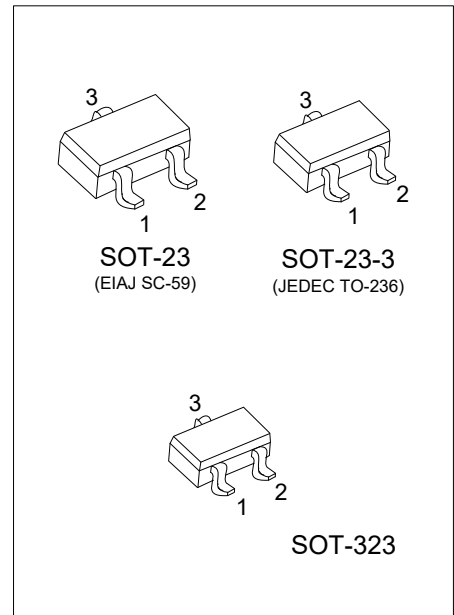


ORDERING INFORMATION

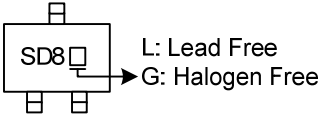
Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
BSS138L-AE2-R	BSS138G-AE2-R	SOT-23-3	G	S	D	Tape Reel
BSS138L-AE3-R	BSS138G-AE3-R	SOT-23	G	S	D	Tape Reel
BSS138L-AL3-R	BSS138G-AL3-R	SOT-323	G	S	D	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

<p>BSS138G-AE2-R</p> 	<p>(1) R: Tape Reel (2) AE2: SOT-23-3, AE3: SOT-23, AL3: SOT-323 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	50	V
Gate-Source Voltage		V_{GSS}	± 20	V
Continuous Drain Current	DC	I_D	0.22	A
	Pulse		0.88	
Peak Diode Recovery dv/dt		dv/dt	7.1	V/ns
Power Dissipation	SOT-23-3	P_D	0.4	W
	SOT-23		0.5	W
	SOT-323		0.15	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.
 Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-23-3	θ_{JA}	312.5	$^\circ\text{C/W}$
	SOT-23		320	$^\circ\text{C/W}$
	SOT-323		833	$^\circ\text{C/W}$

Note: Device mounted on FR-4 substrate P_C board, 2oz copper, with 1inch square copper plate.

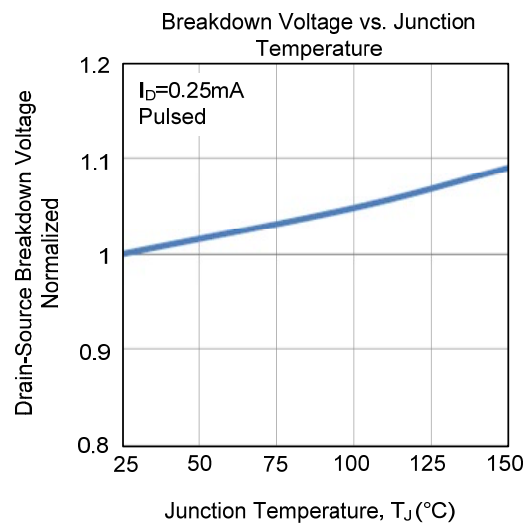
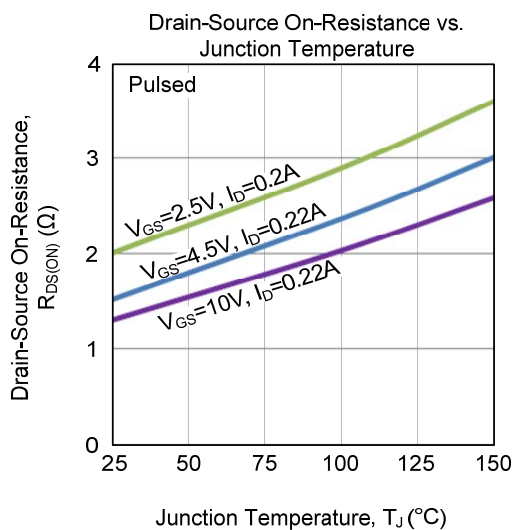
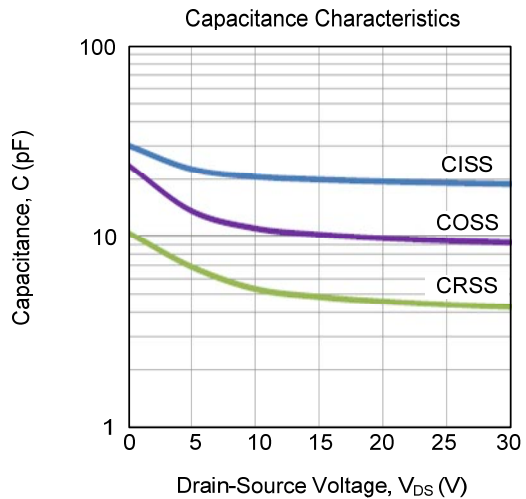
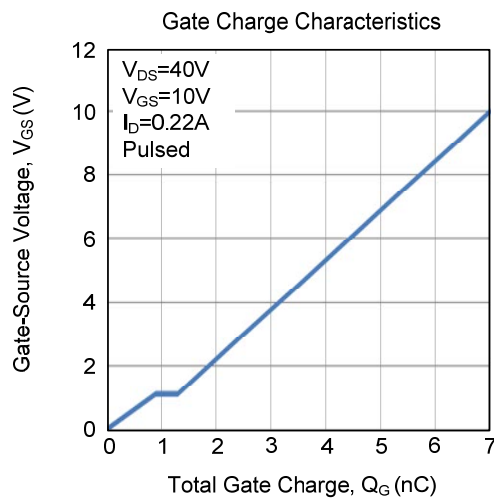
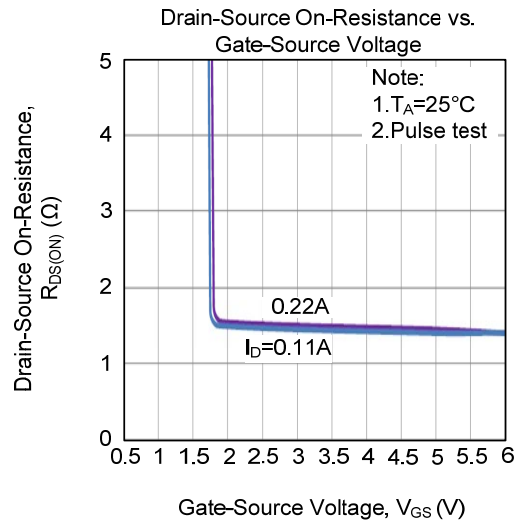
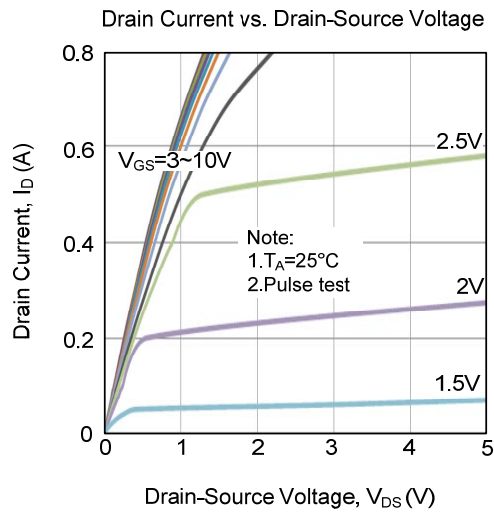
■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA	50			V
Breakdown Voltage Temperature Coefficient	ΔBV _{DSS} /ΔT _J	I _D =250μA, Referenced to 25°C		72		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =50V, V _{GS} =0V			0.5	μA
		V _{DS} =30V, V _{GS} =0V			0.1	μA
Gate-Body Leakage, Forward	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
ON CHARACTERISTICS (Note)						
Gate-Threshold Voltage	V _{GS(TH)}	V _{DS} =V _{GS} , I _D =1mA	0.5	0.9	1.5	V
Gate Threshold Voltage Temperature Coefficient	ΔV _{GS(TH)} /ΔT _J	I _D =1mA, Referenced to 25°C		-2		mV/°C
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =0.22A		1.3	3.5	Ω
		V _{GS} =4.5V, I _D =0.22A		1.5	6.0	Ω
		V _{GS} =2.5V, I _D =0.20A		1.9	8.0	Ω
On-State Drain Current	I _{D(ON)}	V _{GS} =10 V, V _{DS} =5V	0.2			A
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =0.22A	0.12	0.5		S
DYNAMIC PARAMETERS						
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1MHz		19		pF
Output Capacitance	C _{OSS}			9.5		pF
Reverse Transfer Capacitance	C _{RSS}			4.5		pF
SWITCHING PARAMETERS (Note)						
Total Gate Charge	Q _G	V _{DS} =40V, V _{GS} =10V, I _D =0.22A		7		nC
Gate Source Charge	Q _{GS}			0.9		nC
Gate Drain Charge	Q _{GD}			0.4		nC
Turn-ON Delay Time	t _{D(ON)}	V _{DD} =30V, I _D =0.22A, V _{GS} =10V, R _G =6Ω		0.8		ns
Turn-ON Rise Time	t _R			15		ns
Turn-OFF Delay Time	t _{D(OFF)}			6.5		ns
Turn-OFF Fall-Time	t _F			14		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Max. Diode Forward Current	I _S				0.22	A
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0V, I _S =0.44A (Note)		0.8	1.4	V
Reverse Recovery Time	t _{rr}	V _{GS} =0V, I _S =0.22A,		17		ns
Reverse Recovery Charge	Q _{rr}	dI/dt=100A/μs		7		nC

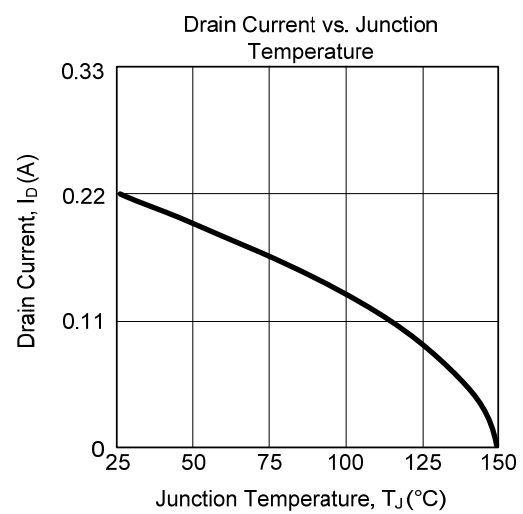
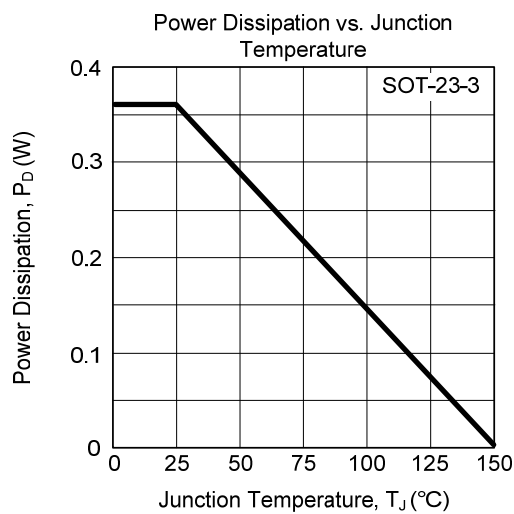
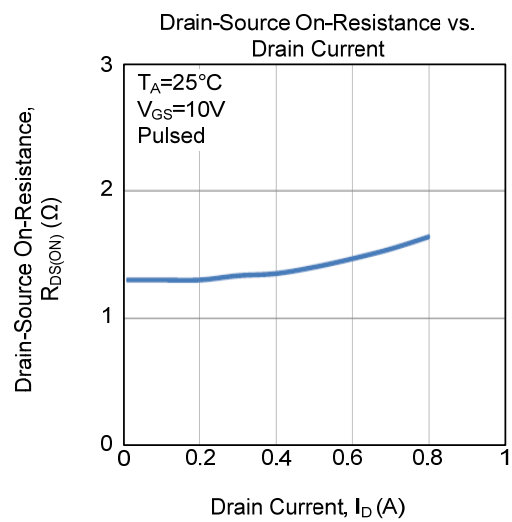
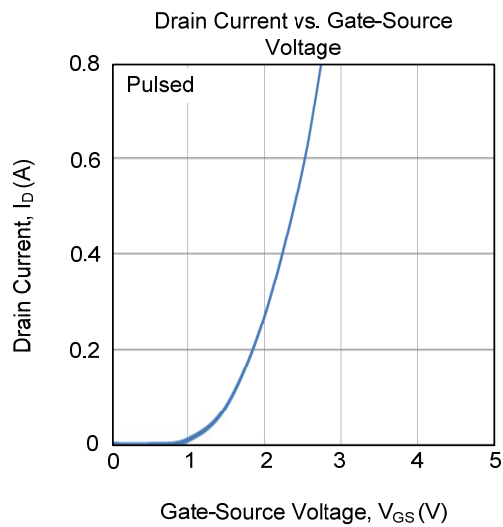
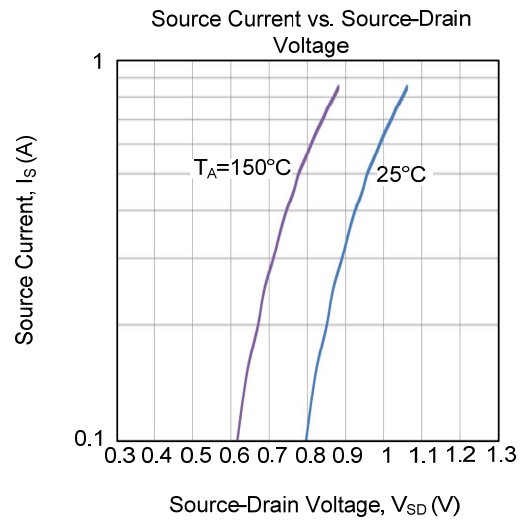
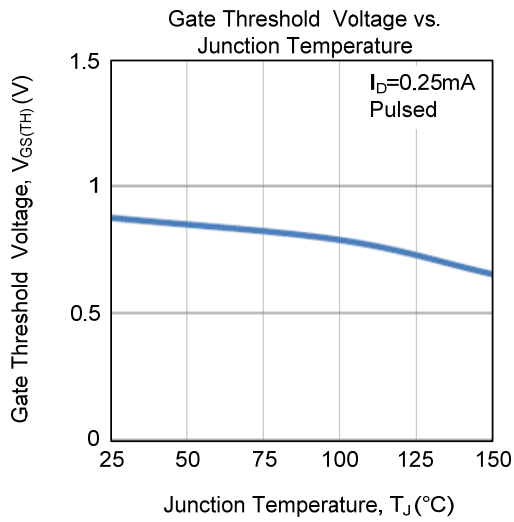
Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

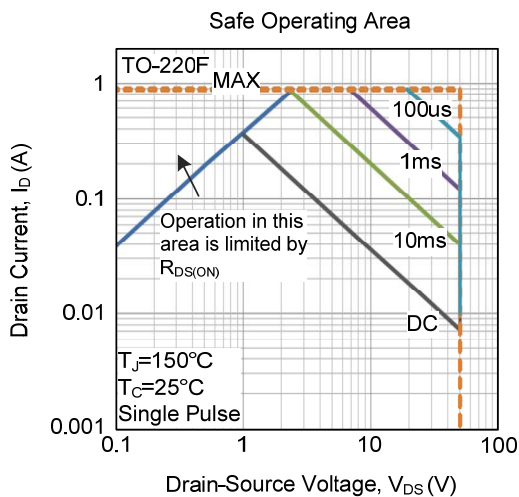
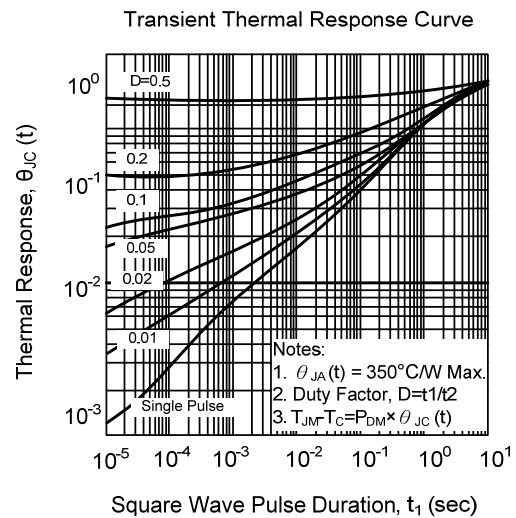
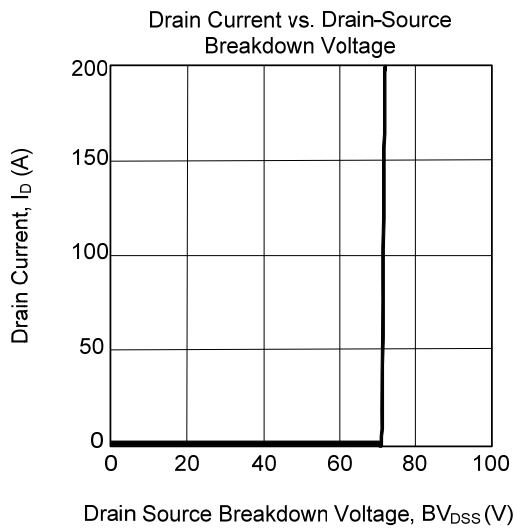
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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